MODEL NO. : TM024HBH39



ISSUED DAT	E: <u>20</u>	10-3-26					
VERSION	: <u>Ve</u>	r 2.0					
	minary S _I Product						
Approved by			Notes				
SHANGHAI TIANMA Confirmed :							
Prepared by	Check	red by	Approved by				

This technical specification is subjected to change without notice



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Record of Revision

Rev	Issued Date	Description	Editor
1.0	2009-12-02	Preliminary Specification Release	Bencan Yang
2.0	2010-3-26	Final specification release	Bencan Yang
			•



1 General Specifications

	Feature	Spec	
	Size	2.4 inch	
	Resolution	240(RGB) x 320	
	Interface	CPU 8/9/16/18 bits	
	Color Depth	262k	
	Technology Type	a-Si	
Display Spec	Pixel Pitch (mm)	0.153x 0.153	
	Pixel Configuration	R.G.B Vertical Stripe	
	Display Mode	TM with Normally White	
	Surface Treatment(Up Polarizer)	Clear Type (3H)	
	Viewing Direction	6 o'clock	
	Gray Scale Inversion Direction	12 o'clock	
	LCM (W x H x D) (mm)	42.72x60.26x3.40	
Mashaniasi	Active Area(mm)	36.72 x 48.96	
Mechanical Characteristics	With /Without TSP	With TSP	
	Weight (g)	14.56	
	LED Numbers	3 LEDs	
Electronic	Driver IC	HX8347G	

Note 1:Viewing direction for best image quality is different from TFT definition, there is a 180 degree shift.

Note 2: Requirements on Environmental Protection: Q/S0002

Note 3: LCM weight tolerance: \pm 5%



2 Input/Output Terminals

2.1 TFT LCD Panel

No	Symbol	I/O	Description	Comment
1	GND	P	Power Ground	Oomment
1	GND	Г	Touch panel coordinate in the down side of envisage	
2	Y-	I/O	drawing	
			Touch panel coordinate in the right side of envisage	
3	X-	I/O	drawing	
			Touch panel coordinate in the up side of envisage	
4	Y+	I/O	drawing	
_			Touch panel coordinate in the left side of envisage	
5	X+	I/O	drawing	F. #
6	GND	Р	Power Ground	
7	IM0	l	Mode select	
8	IM3	l	Mode select	Note2
9	NC	-	Floating	
10	NC	-	Floating	
11	LCD ID	0	LCD identify	Floating
12	RESET	Ī	Reset signal	1.009
13	D9	İ	Data Input	
14	D0	i	Data Input	
15	D17	i	Data Input	
16	D16	i	Data Input	
17	D15	i	Data Input	
18	D14	i	Data Input	
19	D13	i	Data Input	
20	D12	i	Data Input	
21	D11	i	Data Input	
22	D10		Data Input	
23	D8	i	Data input	
24	D7		Data input	
25	D6	The second	Data input	
26	D5		Data input	
27	D4		Data input	
28	D3		Data input	
29	D2	i İ	Data input	
30	D1	1	Data input	
31	RD	<u>'</u>	Read	
32	WR	<u>'</u>	Write	
33	RS	<u>'</u> 	Register select	
34	CS	<u>'</u> 	Chip select	
35	GND	P	Ground	
36	IOVCC	P	Power Supply of Logic Circuit	
37	VCC	P	Power Supply of Analog Circuit	
38	VCC	P	Power Supply of Analog Circuit	
39	NC NC		Floating	
40	LEDK3	- Р	LED cathode	
		<u>Р</u> Р		
41	LEDK2	٢	LED cathode	



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42	LEDK1	Р	LED cathode	
43	LEDA	Р	LED anode	
44	GND	Р	Ground	

Note1: I/O definition: I----Input O---Output P----Power/ Ground NC--- Not Connected

Note2:

10.40	13.40	1.6	Data Bus Use				
IM3	IM0	Interface	Register/Content	GRAM			
0	0	8080 MCU 16bit parallel	D8~D1	D17~D10,D8~D1			
0	1	8080 MCU 8bit parallel	D17~D10	D17~D10			
1	0	8080 MCU 18bit parallel	D8~D1	D17~D0			
1	1	8080 MCU 9bit parallel	D17~D10	D17~D9			



3 Absolute Maximum Ratings

3.1 Driving TFT LCD Panel

GND=0V, Ta=25℃

Item	Symbol	MIN	MAX	Unit	Remark
Logic Supply Voltage	IOVCC	-0.3	4.6	V	
Analog Supply Voltage	VCC	-0.3	4.6	٧	
Input voltage	DB0-DB17,IM0,IM3,RD,RS,CS, WR,RESET	-0.3	IOVCC+0.5	V	
Touch Panel	Vtp	-	7	V	
Back Light Forward Current	I _{LED}	-	25	mA	For each LED
Operating Temperature	T _{OPR}	-20	60	$^{\circ}$	
Storage Temperature	T _{STG}	-30	70	$^{\circ}\mathbb{C}$	



4 Electrical Characteristics

4.1 Driving TFT LCD Panel

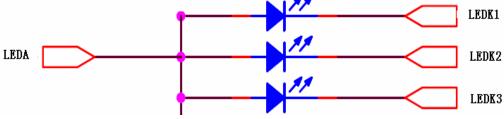
GND=0V, Ta=25°C

Ite	m	Symbol	MIN	TYP	MAX	Unit	Remark
Logic Supply Voltage		IOVCC	1.65	1.8	3.3	٧	
Analog Volta		VCC	2.3	2.8	3.3	٧	
Input Signal	Low Level	V _{IL}	0.7x IOVCC	ı	IOVCC	٧	DB0-DB17,IM0,IM3,RD,
Voltage	High Level	V _{IH}	ı	ı	0.3xIOVCC	>	RS,CS,WR,RESET
Output Signal	Low Level	V _{OL}	0.8xIOVCC	ı	-	V	
Voltage	High Level	V _{OH}	ı	1	0.2xIOVCC	>	
(Panel	+ LSI)	Black Mode (60Hz)	ı	TBD	-	mW	
Power		8 Color Mode	-	TBD	-	mW	
Consu	mption	Sleeping Mode	-	TBD	•	mW	

4.2 Driving Backlight Ta=25℃

Item	Symbol	Min	Тур	Max	Unit	Remark
Forward Current	l _F	-	20	-	mA	For each LED
Forward Voltage	V_{F}	2.9	3.2	3.4	V	For each LED
Power Consumption	W_{BL}	-	192	-	mW	3 LEDs

Note1: Figure below shows the connection of backlight LED.

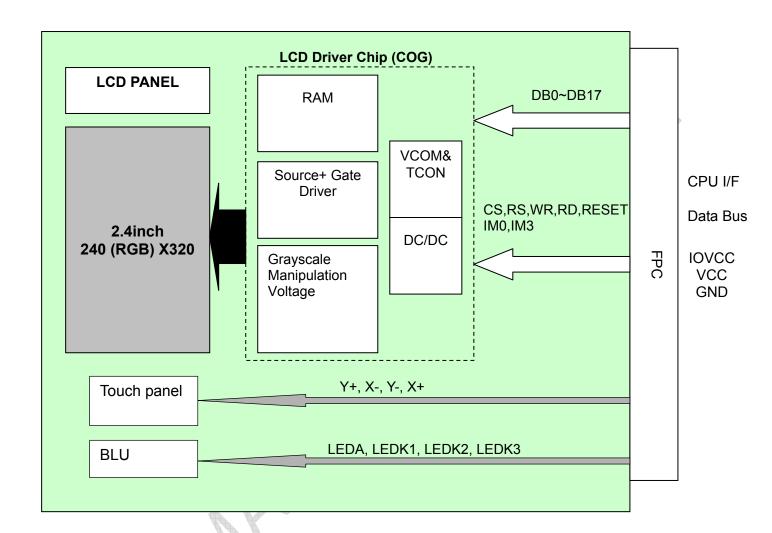


Note 2: One LED: $1/3xI_F = 20$ mA, $V_F = 3.2V$

Note 3: The life of LED: 20,000 hours



4.3 Block Diagram



5 Timing Chart

5.1 Interface Characteristics

Signal	Symbol	Parameter	Spec.			Unit	Description
Sigiral		raidilletei	Min.	Тур	Max.	Oill	Description
DNC_SCL	tAST	Address setup time	10	-	-	ns	_
DNO_562	tAHT	Address hold time (Write/Read)	10	-	-	115	_
NCS	tCHW tCS tRCS tRCSFM tCSF tCSH	Chip select "H" pulse width Chip select setup time (Write) Chip select setup time (Read ID) Chip select setup time (Read FM) Chip select wait time (Write/Read) Chip select hold time	0 15 45 355 10	-		ns	-
	tWC	Write cycle	66	-	-		
NWR_SCL	tWRH	Control pulse "H" duration	15	-	-	ns	-
-	tWRL	Control pulse "L" duration	15	-	-		
NRD(ID)	tRC tRDH tRDL	Read cycle (ID) Control pulse "H" duration (ID) Control pulse "L" duration (ID)	160 90 45	-	-	ns	When read ID data
	tRCFM	Read cycle (FM)	450	-	-		When read
NRD(FM)	tRDHFM	Control pulse "H" duration (FM)	90	-	-	ns	from frame
	tRDLFM	Control pulse "L" duration (FM)	355	-	-		memory
	tDST	Data setup time	10	-	-		For maximum
DB17 to	tDHT	Data hold time	10	-	-		CL=30pF
DB0	tRAT	Read access time (ID)	-	-	100	ns	For minimum
	tRATFM	Read access time (FM)	-	-	340		CL=8pF
Nata The innut	tODH	Output disable time	20		80		op.

Note: The input signal rise time and fall time (tr, tf) is specified at 15 ns or less.

Logic high and low levels are specified as 30% and 70% of IOVCC for Input signals.

Parallel interface characteristics

5.2 Registr Write/Read Timing Parameter

a. Write to register NCS DNC_SCL NRD_E NWR_RNW DB[B:0] "index" write to index register Command write to the register NOTE: DB[B:0] means the data bus which is defined by IMO and IM3, see spec 2.1 NOTE 2.

Figure 5.1 Register write timing in parallel bus system interface (for I80 series MPU)

b. Read to register



NOTE: DB[B:0] means the data bus which is defined by IMO and IM3, see spec 2.1 NOTE 2.

Figure 5.2 Register read timing in parallel bus system interface (for I80 series MPU)

5.3 GRAM write timing in i80 series system

Register	DB17	DB16	DB15	DB14	DB13	DB12	DB11	DB10	DB9	DB8	DB7	DB6	DB5	DB4	DB3	DB2	DB1	DB0	Command
Command	Х	Х	Χ	Χ	Χ	Χ	Х	Χ	Χ	Χ	0	0	1	0	0	0	1	0	22H
17H	DB17	DB16	DB15	DB14	DB13	DB12	DB11	DB10	DB9	DB8	DB7	DB6	DB5	DB4	DB3	DB2	DB1	DB0	Color
	Х	Х	Х	Х	Х	Х	Х	Х	Х	Х	R3	R2	R1	R0	G3	G2	G1	G0	4K-Color
03h	Х	Χ	Χ	Χ	Χ	Χ	Х	Χ	Χ	Χ	В3	B2	B1	B0	R3	R2	R1	R0	(2-pixels/ 3-bytes)
	Х	Χ	Χ	Χ	Χ	Χ	Х	Χ	Χ	Χ	G3	G2	G1	G0	В3	B2	B1	B0	(2 pixels/ 5 bytes)
05h	Х	Х	Х	Х	Х	Х	Х	Х	Х	Х	R4	R3	R2	R1	R0	G5	G4	G3	65K-Color
0311	Х	Х	Х	Х	Х	Х	Х	Х	Х	Х	G2	G1	G0	B4	В3	B2	B1	B0	(1-pixel/ 2-bytes)
	Х	Χ	Χ	Χ	Χ	Χ	Х	Χ	Χ	Χ	R5	R4	R3	R2	R1	R0	Х	Χ	262K Color
06h	Х	Х	Х	Х	Х	Х	Х	Х	Х	Х	G5	G4	G3	G2	G1	G0	Х	Х	262K-Color (1-pixel/ 3bytes)
	Х	Х	Х	Х	Х	Х	Х	Х	Х	Х	B5	В4	В3	B2	B1	B0	х	х	(1 pixes obytes)

Table 5.3.1 8 bit parallel interface GRAM write table

Register	DB17	DB16	DB15	DB14	DB13	DB12	DB11	DB10	DB9	DB8	DB7	DB6	DB5	DB4	DB3	DB2	DB1	DB0	Command
Command	Х	Χ	Х	Х	Х	Χ	Х	Χ	Х	Χ	0	0	1	0	0	0	1	0	22H
17H	DB17	DB16	DB15	DB14	DB13	DB12	DB11	DB10	DB9	DB8	DB7	DB6	DB5	DB4	DB3	DB2	DB1	DB0	Color
03h							R3	R2	R1	R0	G3	G2	G1	G0	В3	B2	B1	B0	4K-Color
05h	Х	Χ	R4	R3	R2	R1	R0	G5	G4	G3	G2	G1	G0	B5	B4	В3	B2	B1	65K-Color
	Х	Х	R5	R4	R3	R2	R1	R0	Х	Х	G5	G4	G3	G2	G1	G0	Х	Х	2021/ 0-1
06h	Х	Х	B5	B4	В3	B2	B1	B0	х	Х	R5	R4	R3	R2	R1	R0	х	х	262K-Color (2-pixels/ 3bytes)
4	Х	Х	G5	G4	G3	G2	G1	G0	Х	Х	B5	B4	В3	B2	B1	В0	Х	Х	(2 pixels/ obytes)
07h	Х	Χ	R5	R4	R3	R2	R1	R0	G5	G4	G3	G2	G1	G0	B5	B4	В3	B2	262K-Color (16+2)
0/11	Х	Х	Х	Х	Х	Х	Х	Х	Х	Х	Х	Х	Х	Х	Χ	Х	B1	B0	2021(-00101 (1012)

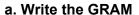
Table 5.3.2 16bit parallel interface GRAM write table

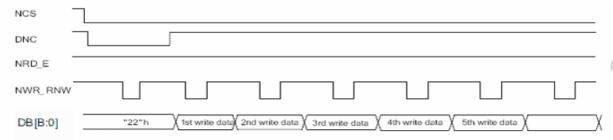
Register	DB17	DB16	DB15	DB14	DB13	DB12	DB11	DB10	DB9	DB8	DB7	DB6	DB5	DB4	DB3	DB2	DB1	DB0	Register
Command	Х	Х	Χ	Х	Х	Х	Х	Χ	Χ	Х	0	0	1	0	0	0	1	0	22H
17H	DB17	DB16	DB15	DB14	DB13	DB12	DB11	DB10	DB9	DB8	DB7	DB6	DB5	DB4	DB3	DB2	DB1	DB0	Color
06h	Х	Х	Х	Х	Х	Χ	Х	Х	Х	R5	R4	R3	R2	R1	R0	G5	G4	G3	262K-Color
UOII	Х	Х	Х	Х	Х	Х	Х	Х	х	G2	G1	G0	B5	B4	В3	B2	B1	В0	(1-pixels/ 2bytes)

Table 5.3.3 9 bit parallel interface GRAM write table

	1	2.3			3.13														
Register	DB17	DB16	DB15	DB14	DB13	DB12	DB11	DB10	DB9	DB8	DB7	DB6	DB5	DB4	DB3	DB2	DB1	DB0	Register
Command	Х	Х	Х	Х	Х	Х	Х	Х	Х	Х	0	0	1	0	0	0	1	0	22H
17H	DB17	DB16	DB15	DB14	DB13	DB12	DB11	DB10	DB9	DB8	DB7	DB6	DB5	DB4	DB3	DB2	DB1	DB0	Color
06h	R5	R4	R3	R2	R1	R0	G5	G4	G3	G2	G1	G0	B5	B4	B3	B2	B1	B0	262K-Color

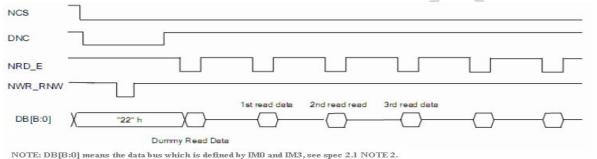
Table 5.3.4 18 bit parallel interface GRAM write table





NOTE: DB[B:0] means the data bus which is defined by IMO and IM3, see spec 2.1 NOTE 2.

b. Read the GRAM



5.4 Reset Timing Characteristics

700 000					
Item	Symbol	Unit	Min.	Тур.	Max.
RESET low pulse width	tRESW	us	10	ı	-
Reset complete time (STB out mode)	tREST	ms	5	-	
Reset complete time (STB mode)	INEST	ms	120		
Reset goes high lever after power on time	tPRES	ms	1		

Table 5.4.1 RESET Timing Parameter

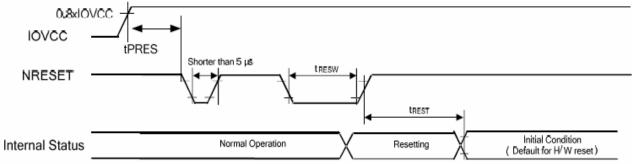
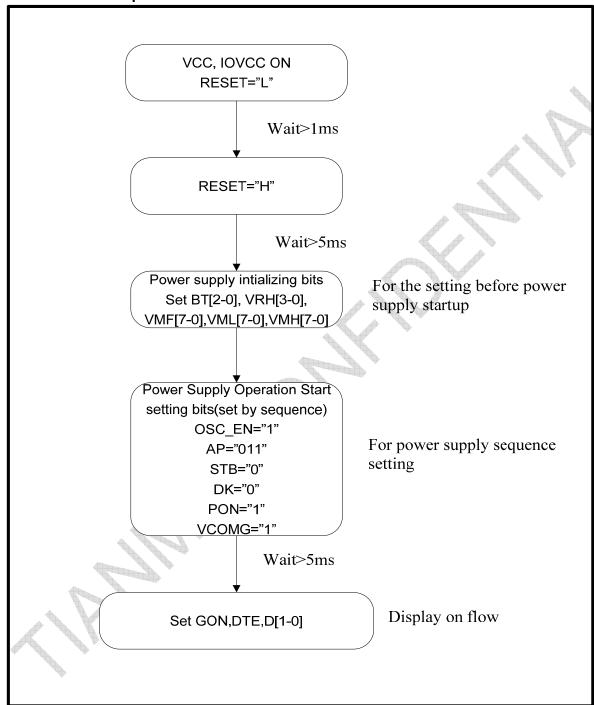


Figure 5.4.2 RESET Timing



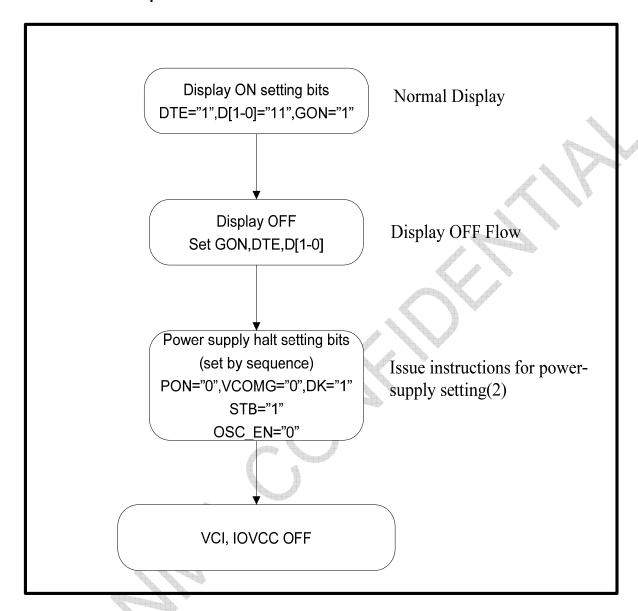
5.5 Power on/off Sequence

5.5.1 Power on sequence





5.5.2 Power off sequence





6 Optical Characteristics

Ta=25°C

Item		Symbol	Condition	Min	Тур	Max	Unit	Remark	
		θТ		40	50	-			
Viou And	ulaa	θВ	CR≧10	40	20	-	Dograd	Note 2	
View Ang	jies	θL	CR=10	15	45	-	Degree	Note 2	
		θR		35	45	-			
Contrast F	Ratio	CR	θ=0°	300	350	-		Note1 Note3	
Response	Time	Ton	25℃	_	20	30	ms	Note1	
rtesponse	Tillie	Toff	25 0	_	20	30	1113	Note4	
	White	Х		0.235	0.285	0.335			
	VVIIIC	у		0.255	0.305	0.355			
	Red	X		0.540	0.590	0.640			
Chromaticity		у	Backlight is	Backlight is		0.280	0.330	0.380	
Cilioniaticity	Green	X	on	0.280	0.330	0.380		Note1	
	Green	у		0.530	0.580	0.630			
	Blue	X		0.110	0.150	0.200			
	Dide	у		0.050	0.100	0.150			
Uniformity		U		-	80	-	%	Note1 Note6	
NTSC				-	50	-	%	Note 5	
Luminan	ice	L		160	180	-	cd/m ²	Note1 Note7	

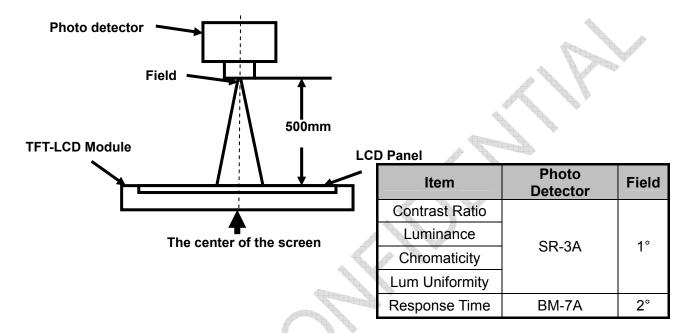
Test Conditions:

- 1. For one LED: V_F =3.2V, $1/3xI_F$ =20mA, the ambient temperature is 25 °C.
- 2. The test systems refer to Note 1 and Note 2.



Note 1: Definition of optical measurement system.

The optical characteristics should be measured in dark room. After 5 minutes operation, the optical properties are measured at the center point of the LCD screen. All input terminals LCD panel must be ground when measuring the center area of the panel.



Note 2: Definition of viewing angle range and measurement system.

viewing angle is measured at the center point of the LCD by CONOSCOPE(ergo-80).

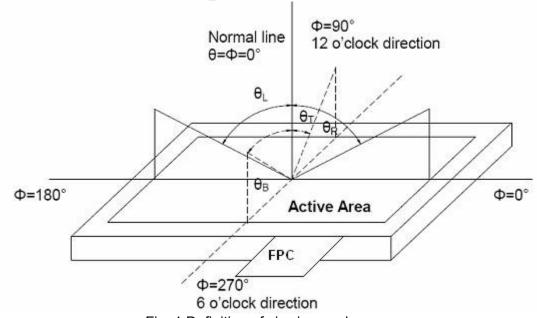


Fig. 1 Definition of viewing angle



Note 3: Definition of contrast ratio

Contrast ratio (CR) =
\[\frac{\text{Luminance measured when LCD is on the "White" state}}{\text{Luminance measured when LCD is on the "Black" state}} \]

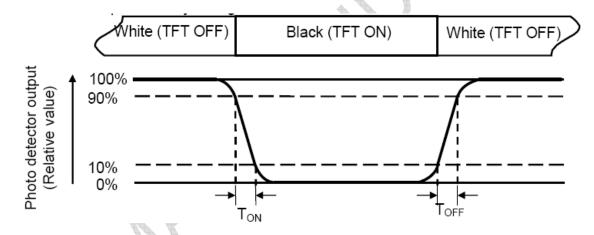
"White state ": The state is that the LCD should driven by Vwhite.

"Black state": The state is that the LCD should driven by Vblack.

Vwhite: To be determined Vblack: To be determined.

Note 4: Definition of Response time

The response time is defined as the LCD optical switching time interval between "White" state and "Black" state. Rise time (TON) is the time between photo detector output intensity changed from 90% to 10%. And fall time (TOFF) is the time between photo detector output intensity changed from 10% to 90%.



Note 5: Definition of color chromaticity (CIE1931)

Color coordinates measured at center point of LCD.



Note 6: Definition of Luminance Uniformity

Active area is divided into 9 measuring areas (Refer Fig. 2). Every measuring point is placed at the center of each measuring area.

Luminance Uniformity(U) = Lmin/Lmax

L----- Active area length W----- Active area width

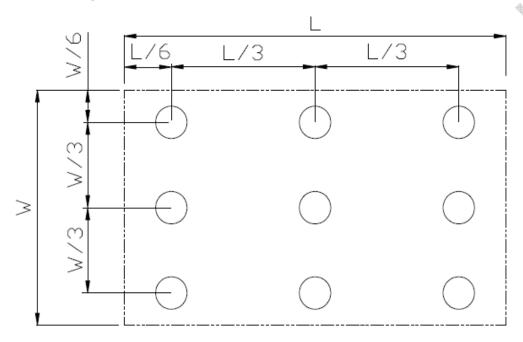


Fig. 2 Definition of uniformity

Lmax: The measured maximum luminance of all measurement position.

Lmin: The measured minimum luminance of all measurement position.

Note 7: Definition of Luminance:

Measure the luminance of white state at center point.



7 Environmental / Reliability Tests

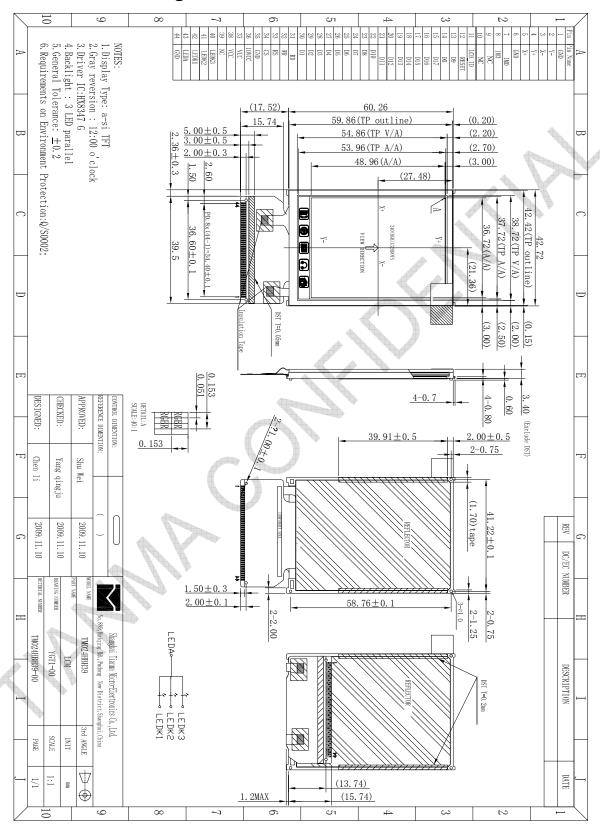
No	Test Item	Condition	Remarks
1	High Temperature Operation	Ts=+60℃, 240hrs	Note1 IEC60068-2-1:2007,GB2423.2-2008
2	Low Temperature Operation	Ta=-20℃, 240hrs	IEC60068-2-1:2007 GB2423.1-2008
3	High Temperature Storage	Ta=+70℃, 240hrs	IEC60068-2-1:2007 GB2423.2-2008
4	Low Temperature Storage	Ta=-30℃, 240hrs	IEC60068-2-1:2007 GB2423.1-2008
5	High Temperature & High Humidity Storage	Ta=+60℃, 90% RH 240 hours	Note2 IEC60068-2-78 :2001 GB/T2423.3—2006
6	Thermal Shock (Non-operation)	-30°C 30 min~+70°C 30 min, Change time:5min, 20 Cycles	Start with cold temperature, End with high temperature, IEC60068-2-14:1984,GB2423.22-2002
7	Electro Static Discharge (Operation)	C=150pF, R=330 Ω , 5points/panel Air:±8KV, 5times; Contact:±4KV, 5 times; (Environment: 15 $^{\circ}$ C \sim 35 $^{\circ}$ C, 30% \sim 60%, 86Kpa \sim 106Kpa)	IEC61000-4-2:2001 GB/T17626.2-2006
8	Vibration (Non-operation)	Frequency range:10~55Hz, Stroke:1.5mm Sweep:10Hz~55Hz~10Hz 2 hours for each direction of X.Y.Z. (6 hours for total) (Package condition)	IEC60068-2-6:1982 GB/T2423.10—1995
9	Shock (Non-operation)	60G 6ms, ±X,±Y,±Z 3times, for each direction	IEC60068-2-27:1987 GB/T2423.5—1995
10	Package Drop Test	Height:80 cm, 1 corner, 3 edges, 6 surfaces	IEC60068-2-32:1990 GB/T2423.8—1995

Note1: Ts is the temperature of panel's surface.

Note2: Ta is the ambient temperature of sample.

\checkmark

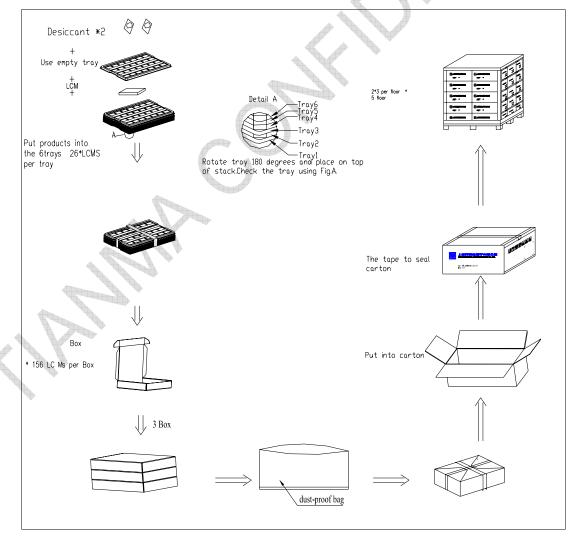
8 Mechanical Drawing





9 Packing Drawing

No	Item	Model (Material)	Dimensions(mm)	Unit Weight(Kg)	Quantity	Remark
1	LCM module	TM024HBH39	42.72x60.26x3.40	0.01456	468	
2	Tray	PET (Transmit)	485X330X13.8	0.167	26	Anti-stati c
3	Dust-Proof Bag	Dust-Proof Bag	700x545	0.021	1	
4	вох	CORRUGATED PAPER	520x345x74	0.227	3	
5	Desiccant	Desiccant	45×50	0.0035	6	
6	Carton	CORRUGATED PAPER	544×365×250	1.01	1	
7	Total weight		12.89			•



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10 Precautions for Use of LCD Modules

- 11.1 Handling Precautions
- 11.1.1 The display panel is made of glass. Do not subject it to a mechanical shock by dropping it from a high place, etc.
- 11.1.2 If the display panel is damaged and the liquid crystal substance inside it leaks out, be sure not to get any in your mouth, if the substance comes into contact with your skin or clothes, promptly wash it off using soap and water.
- 11.1.3 Do not apply excessive force to the display surface or the adjoining areas since this may cause the color tone to vary.
- 11.1.4 The polarizer covering the display surface of the LCD module is soft and easily scratched. Handle this polarizer carefully.
- 11.1.5 If the display surface is contaminated, breathe on the surface and gently wipe it with a soft dry cloth. If still not completely clear, moisten cloth with one of the following solvents:
 - Isopropyl alcohol、
 - Ethyl alcohol

Solvents other than those mentioned above may damage the polarizer. Especially, do not use the following:

- Water
- Ketone
- Aromatic solvents
- 11.1.6 Do not attempt to disassemble the LCD Module.
- 11.1.7 If the logic circuit power is off, do not apply the input signals.
- 11.1.8 To prevent destruction of the elements by static electricity, be careful to maintain an optimum work environment.
- 11.1.8.1 Be sure to ground the body when handling the LCD Modules.
- 11.1.8.2 Tools required for assembly, such as soldering irons, must be properly ground.
- 11.1.8.3 To reduce the amount of static electricity generated, do not conduct assembly and other work under dry conditions.
- 11.1.8.4 The LCD Module is coated with a film to protect the display surface. Be care when peeling off this protective film since static electricity may be generated.
 - 11.2 Storage precautions
- 11.2.1 When storing the LCD modules, avoid exposure to direct sunlight or to the light of fluorescent lamps.
- 11.2.2 The LCD modules should be stored under the storage temperature range. If the LCD modules will be stored for a long time, the recommend condition is:

Temperature : 0° C $\sim 40^{\circ}$ C Relatively humidity: $\leq 80\%$

- 11.2.3 The LCD modules should be stored in the room without acid, alkali and harmful gas.
 - 11.3 Transportation Precautions:

The LCD modules should be no falling and violent shocking during transportation, and also should avoid excessive press, water, damp and sunshine.